

TOSHIBA CDMOS Integrated Circuit Silicone Monolithic

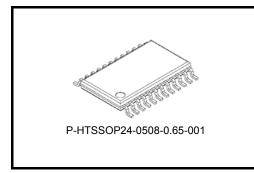
# TC62D722CFNG

16-Output constant current LED driver with the output gain control function and the PWM grayscale function

#### **Feature**

The TC62D722CFNG is LED drivers which have the sink-type constant current output. The 8-bit output gain control function and 16, 14, 12, and 10-bit PWM grayscale functions are built in this IC. Output current values of 16 channels can be set by one external resistance. In addition, the thermal shutdown function, the output open detection function, and the output short detection function are built in.

This product is suitable for LED modules and lighting displays.



Weight: 0.10 g (typ.)

#### **Characteristics**

Supply voltage : V<sub>DD</sub> = 3.0 to 5.5 V

• 16 outputs built-in

Output current setup range : I<sub>OUT</sub> = 1.5 to 90 mA

· Constant current output accuracy

(@ REXT =  $1.2 \text{ k}\Omega$ , Vout = 1.0 V, VDD = 3.3 V, 5.0 V)

: N rank (Standard); Between outputs ± 2.5 % (max), Between devices: ± 2.5 % (max)

: S rank (Special production); Between outputs ± 1.5 % (max), Between devices: ± 1.5 % (max)

Output voltage : Vout = 17 V (max)

• I/O interface : CMOS interfaces (Input of a schmitt trigger)

Data transfer frequency : fsck = 30 MHz (max)
 PWM frequency : fpwm = 33 MHz (max)
 Operation temperature range : Topr = -40 to 85 °C
 8-bit (256 steps) output gain control function built-in.

PWM gray scale function built-in. (PWM resolution is selectable)

16 bits (65536 steps), 14 bits (16384 steps), 12 bits (4096 steps), and 10 bits (1024 steps)

- Thermal shutdown function (TSD) built-in.
- Output error detection function built-in.

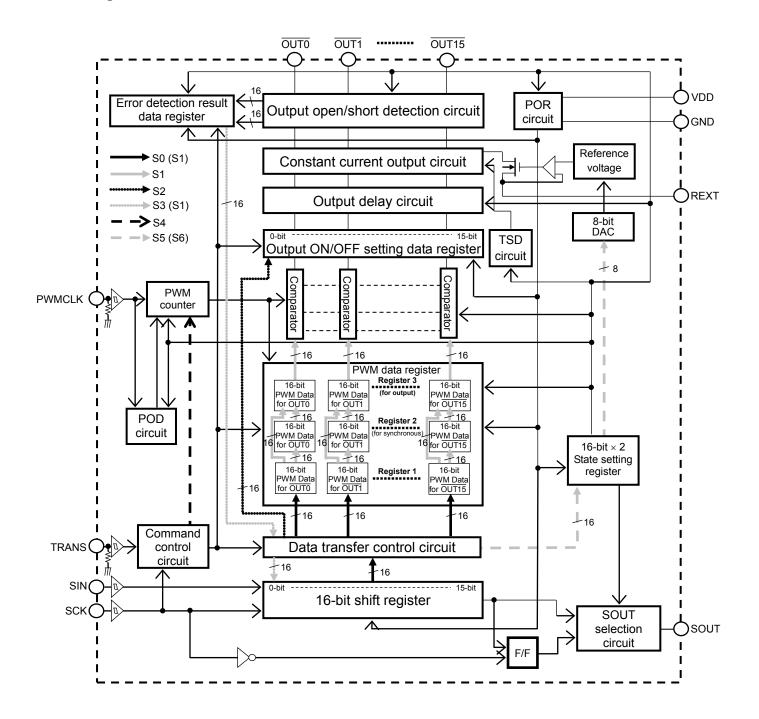
This function has the automatic operation and the command input manual operation.

Output open detection function (OOD) and output short detection function (OSD) built-in.

- Power-on-reset function built-in. (When the power supply is turned on, internal data is reset)
- Stand-by function built-in. (IDD=1 μA (max) at standby mode)
- Output delay function built-in. (Output switching noise is reduced)
- Package : P-HTSSOP24-0508-0.65-001



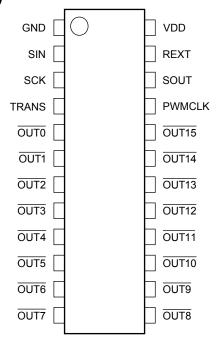
### **Block Diagram**



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# Pin Assignment (top view)



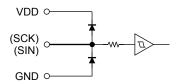
# **Pin Description**

Pin No	Pin Name	I/O	Function
1	GND	_	The ground pin.
2	SIN	I	The serial data input pin.
3	SCK	I	The serial data transfer clock input pin.
4	TRANS	I	The data transfer command input pin.
5	OUT0	0	The sink type constant current output pin.
6	OUT1	0	The sink type constant current output pin.
7	OUT2	0	The sink type constant current output pin.
8	OUT3	0	The sink type constant current output pin.
9	OUT4	0	The sink type constant current output pin.
10	OUT5	0	The sink type constant current output pin.
11	OUT6	0	The sink type constant current output pin.
12	OUT7	0	The sink type constant current output pin.
13	OUT8	0	The sink type constant current output pin.
14	OUT9	0	The sink type constant current output pin.
15	OUT10	0	The sink type constant current output pin.
16	OUT11	0	The sink type constant current output pin.
17	OUT12	0	The sink type constant current output pin.
18	OUT13	0	The sink type constant current output pin.
19	OUT14	0	The sink type constant current output pin.
20	OUT15	0	The sink type constant current output pin.
21	PWMCLK	I	The reference clock input pin for PWM grayscale control.  One cycle of the input clock becomes a minimum pulse width of the PWM output.
22	SOUT	0	The serial data output pin.
23	REXT	_	The constant current value setting resistor connection pin.
24	VDD	_	The power supply input pin.

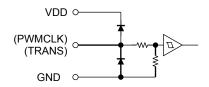


# Equivalent circuit of input and output

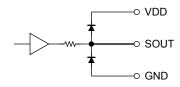
# (1). SCK, SIN



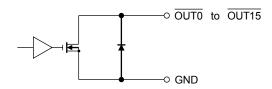
# (2). PWMCLK, TRANS



# (3). SOUT



# (4). OUT0 to OUT15





1. Explanation of the function (Basic data input pattern)

Data input is done with the SIN pin and the SCK pin. Command selection is done with the SCK pin and the TRANS pin.

About the operation of each command

Command	Number of SCK pulses at TRANS="H" (Note3)	Operation
S0	0, 1	The PWM data in the 16-bit shift register is transmitted to the PWM data register 1.
S1	2, 3	The PWM data in the PWM data register 1 is transmitted to the PWM data register 2 or 3. (Note1)     The automatic output open/short detection result data is transmitted to the 16-bit shift register. (Note2)     PWM output start.
S2	7, 8	Input of the output ON/OFF data. (When this function is not used, this input is unnecessary.)
S3	9, 10	The manual output open/short detection functions are executed. (Note2) The manual output open/short detection result data is transmitted to the 16-bit shift register. (Note2)
S4	11, 12	Reset of the internal PWM counter.
S5	13, 14	Input of the state setting data (1).
S6	15, 16	Input of the state setting data (2).

Note1: Transmitted register changes by a PWM counter synchronization setting.

	his operation is performed when the output open/short det other SCK numbers are disregarded.	ection function is "Active" setting.	
•S0 comm	nand (The PWM data is transmitted to the P\	VM data register 1.)	
SCK			
TRANS		Number of SCK pulses at TRANS="H" is 0 or 1.	$\overline{\downarrow}$
SIN	PWM DATA		
•S1 comn	nand (The PWM data is transmitted to the P\	VM data register 2 or 3.)	
SCK		1 2 3	
TRANS	Data input of the 16-bit shift register is unnecessary.	Number of SCK pulses at TRANS="H" is 2 or 3	$\neg$
SIN			
•S2 comn	nand (Input of the output ON/OFF data.)		
SCK		1 2 3 4 5 6 7 8	
TRANS		Number of SCK pulses at TRANS="H" is 7 or 8	$\downarrow$
SIN	OUTPUT ON/OFF DATA		
•S3 comn	nand (The output open/short detection func	tions manual operation is executed.)	
SCK		1 2 3 4 5 6 7 8 9 10	
TRANS	Data input of the 16-bit shift register is unnecessary.	Number of SCK pulses at TRANS="H" is 9 or 10	$\downarrow$
SIN			
•S4 comn	nand (Reset of the internal PWM counter.)		
SCK			
TRANS	Data input of the 16-bit shift register is unnecessary.	Number of SCK pulses at TRANS="H" is 11 or 12	$\downarrow$
SIN			
•S5 comn	nand (Input of the state setting data (1).)		
SCK			
TRANS		Number of SCK pulses at TRANS="H" is 13 or 14	
SIN	STATE SETTING DATA (1)		
•S6 comn	nand (Input of the state setting data (2).)		
SCK			
TRANS		Number of SCK pulses at TRANS="H" is 15 or 16	
SIN	STATE SETTING DATA (2)		

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### 2. About the operation of each command

#### 2.1. S0 command

## 2.1.1. The PWM data is transmitted to the PWM data register 1.

Operation) In the number of SCK pulses at TRANS="H" is 0 or 1, the following operation is executed.

The PWM data in the 16-bit shift register is transmitted to the PWM data register 1.

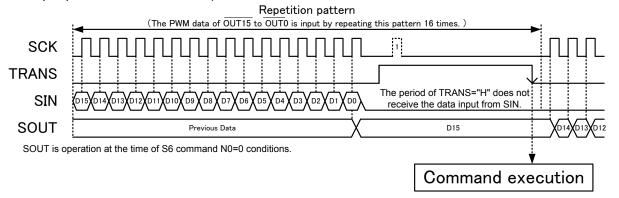
It is necessary to repeat this command 16 times to input the PWM data of OUT0 to OUT15.

The order of the PWM data transfer is the following.

$$\overline{\text{OUT15}} \to \overline{\text{OUT14}} \to \overline{\text{OUT13}} \to \overline{\text{OUT12}} \to \overline{\text{OUT11}} \to \overline{\text{OUT10}} \to \overline{\text{OUT9}} \to \overline{\text{OUT8}}$$

$$\to \overline{\text{OUT7}} \to \overline{\text{OUT6}} \to \overline{\text{OUT5}} \to \overline{\text{OUT4}} \to \overline{\text{OUT3}} \to \overline{\text{OUT2}} \to \overline{\text{OUT1}} \to \overline{\text{OUT0}}$$

### Basic input pattern of S0 command)





### 2.1.2. Input form of the PWM data

PWM resolution is set by the S5 command. Default setting is "16-bit".

# (1). 16-bit PWM setting

MSB															LSB	
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	PWM setting (reference)
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0/65535(Default)
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1/65535
0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	2/65535
:	:	:	:	:	:	:	:	:	:	:	:	:	:	:		:
1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	1	65533/65535
1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	65534/65535
1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	65535/65535

D15 to D0 is serial-data-inputted at MSB first.

# (2). 14-bit PWM setting

MSB															LSB	
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	PWM setting (reference)
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0/16383(Default)
		0	0	0	0	0	0	0	0	0	0	0	0	0	1	1/16383
		0	0	0	0	0	0	0	0	0	0	0	0	1	0	2/16383
Don't	Don't care		÷	÷	÷	÷	÷	÷	÷	÷	÷	÷	÷	÷	÷	÷
		1	1	1	1	1	1	1	1	1	1	1	1	0	1	16381/16383
			1	1	1	1	1	1	1	1	1	1	1	1	0	16382/16383
		1	1	1	1	1	1	1	1	1	1	1	1	1	1	16383/16383

D15 to D0 is serial-data-inputted at MSB first.

# (3). 12-bit PWM setting

MSB															LSB	
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	PWM setting (reference)
				0	0	0	0	0	0	0	0	0	0	0	0	0/4095(Default)
				0	0	0	0	0	0	0	0	0	0	0	1	1/4095
				0	0	0	0	0	0	0	0	0	0	1	0	2/4095
	Don'	t care		:		::	:	÷	÷	÷	:	:	÷	÷		:
				1	1	1	1	1	1	1	1	1	1	0	1	4093/4095
				1	1	1	1	1	1	1	1	1	1	1	0	4094/4095
				1	1	1	1	1	1	1	1	1	1	1	1	4095/4095

D15 to D0 is serial-data-inputted at MSB first.

# (4). 10-bit PWM setting

MSB															LSB	
D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	PWM setting (reference)
						0	0	0	0	0	0	0	0	0	0	0/1023(Default)
						0	0	0	0	0	0	0	0	0	1	1/1023
						0	0	0	0	0	0	0	0	1	0	2/1023
	Don't care					::	:	÷	:	::		:	:	÷		:
						1	1	1	1	1	1	1	1	0	1	1021/1023
						1	1	1	1	1	1	1	1	1	0	1022/1023
						1	1	1	1	1	1	1	1	1	1	1023/1023

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D15 to D0 is serial-data-inputted at MSB first.

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#### 2.2. S1 command

### 2.2.1. The PWM data is transmitted to the PWM data register 2 or 3.

Operation) In the number of SCK pulses at TRANS="H" is 2 or3, the following operation is executed.

1. The PWM data in the PWM data register 1 is transmitted to the PWM data register 2 or 3.

2. The automatic output open/short detection result data is transmitted to the 16-bit shift register. (Note1)

When internal PWM count is 1 to 21, the <u>output open/short</u> detection automatic operation is done. the detection current flows to the  $\overline{\text{OUT}0}$  to  $\overline{\text{OUT}15}$  terminal. The detection current is about 4µA. In the following cases, please note that the correct detection result may not be transferred.

In case that PWM pulse length is short

In case of division PWM output system

(Factor: OUTn is turned off before the number of count reaches 21 counts.)

3. The PWM output start.

In the input of this command, the PWM output is turned on once. When restarting by same PWM data, please input this command again.

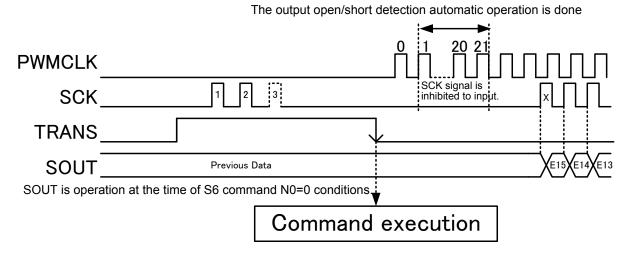
Remarks) About the output operation when this command is input while PWM output.

When the PWM counter is the synchronous mode. (After turning on the power supply, the PWM counter is the synchronous mode)
 After the present PWM output has ended, PWM output is started by new PWM data. (Note2)

2. When the PWM counter is the asynchronous mode. (Note2)

The present PWM output is canceled and a PWM output is immediately started by new PWM data.

Basic input pattern of S1 command)



The first SCK (signal X in the above figure) after S1 command is used for transmission of the output open/short detection result data. The input from SIN is not received. Note1

Note1: This operation is performed when the output open/short detection function is "Active" setting. The output open/short detection functions are set by S6 command. Default setting is "Not Active".

Note2: PWM output synchronization PWM resolution is set by the S6 command. Default setting is "Synchronous mode".



### 2.2.2. Output form of the output open/short detection result data

It is transmitted to 16 bit-shift register in the following form.

MSB LSB

E15	E14	E13	E12	E11	E10	E9	E8	E7	E6	E5	E4	E3	E2	E1	E0
OUT15	OUT14	OUT13	OUT12	OUT11	OUT10	OUT9	OUT8	OUT7	OUT6	OUT5	OUT4	OUT3	OUT2	OUT1	OUT0

E15 to E0 is serial-data-outputted at MSB first.

Error code (when output open detection function is effective)

The state of output	Error code	Condition of output
V <sub>OOD</sub> ≥ V <sub>OUT</sub>	0	Open
V <sub>OOD</sub> < V <sub>OUT</sub>	1	Normal

Error code (when output short detection function is effective)

The state of output	Error code	Condition of output
V <sub>OSD1/2</sub> ≤ V <sub>OUT</sub>	0	short-circuit
$V_{OSD1/2} > V_{OUT}$	1	Normal

Error code (when output open/short detection function is effective)

_	` ' '		,						
	The state of output	Error code	Condition of output						
	$V_{OOD} \ge V_{OUT}$ or $V_{OSD1/2} \le V_{OUT}$	0	Open or short-circuit						
	$V_{OOD} < V_{OUT}$ or $V_{OSD1/2} > V_{OUT}$	1	Normal						
	When both output error detection function is effective, Open and short-circuit are undistinguishable.								

When internal PWM count is 1 to 21, the output open/short detection automatic operation is done. When the output is off during the output open/short detection execution, the error code becomes "1".

Setting of	Setting of	The PWM step that becomes error code "1"
PWM output mode	PWM bits number	without relations in the state of the output pin.
	16 bit PWM setting	
Normal	14 bit PWM setting	O to 20 DIAM stangation
PWM output mode	12 bit PWM setting	0 to 20 PWM stepsetting
•	10 bit PWM setting	
	16 bit PWM setting	
Division	14 bit PWM setting	0 to 2560 PWM stepsetting
PWM output mode	12 bit PWM setting	
·	10 bit PWM setting	0 to 960 PWM stepsetting

The above table is unrelated at the time of the output open/short detection manual operation by S3 command.



#### 2.3. S2 command

### 2.3.1. Input of the output ON/OFF data.

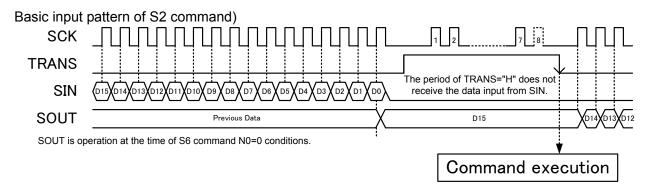
When this function is not used, this input is unnecessary.

Operation) In the number of SCK pulses at TRANS="H" is 7 or 8, the following operation is executed. Input of the output ON/OFF data.

Even if PWM data is not changed to 0 settings, ON/OFF of the output can be controlled.

Remarks) About the output operation when this command is input while PWM output.

- 1. When the PWM counter is the synchronous mode. (Note1)
  The setting of this command is reflected in the next PWM output.
- 2. When the PWM counter is the asynchronous mode. (Note1) The setting of this command is reflected immediately.



Note1: PWM output synchronization PWM resolution is set by the S6 command. Default setting is "Synchronous mode".

### 2.3.2. Input form of the output ON/OFF data

MSB LSB

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
OUT15	OUT14	OUT13	OUT12	OUT11	OUT10	OUT9	OUT8	OUT7	OUT6	OUT5	OUT4	OUT3	OUT2	OUT1	OUT0

D15 to D0 is serial-data-inputted at MSB first.

The output ON/OFF data setting

Input Data	Setting
1	Output operates according to PWM data setting. (Default)
0	Output turn off



### 2.4. S3 command (The manual output open/short detection functions are executed.)

Operation) In the number of SCK pulses at TRANS="H" is 9 or 10, the following operation is executed. (Note1) The manual output open/short detection functions are executed.

The output is compulsorily turned on during ton(s3) with about 80 µA. And detection is done.

The manual output open/short detection result data is transmitted to the 16-bit shift register.

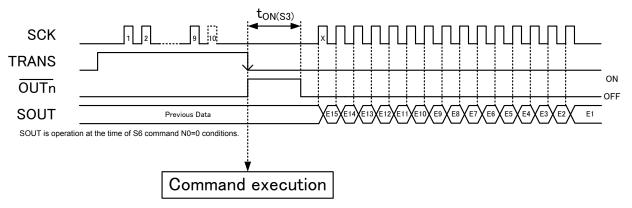
The output format which shows the transferred result of output open / short detection is same as the S1 command one.

ton(s3) is about 800 ns.

Remarks) For the period of toN(S3), please set SCK and TRANS to "L".

When inputting this command during PWM output, the manual output open/short detection functions are executed after the PWM output. In this case, ton(s3) occurs after a PWM output.

Basic input pattern of S3 command)



The first SCK (signal X in the above figure) after this command is used for transmission of the output open/short detection result data. The input from SIN is not received. (Note1)

Note1: This operation is performed when the output open/short detection function is "Active" setting. The output open/short detection functions are set by S6 command. Default setting is "Not Active".

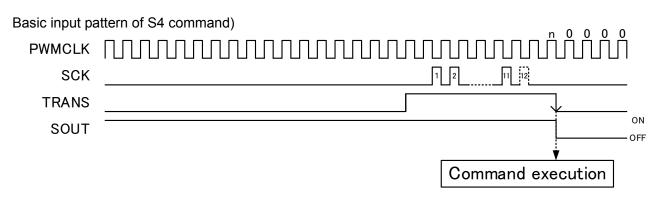
#### 2.5. S4 command (Reset of the internal PWM counter.)

Operation) In the number of SCK pulses at TRANS="H" is 11 or 12, the following operation is executed.

The internal PWM counter is reset.

When the internal PWM counter is reset, the output is turned off.

Remarks) S1 command input is required for outputting pulse again after S4 command execution.



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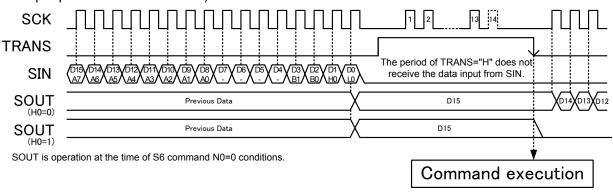


#### 2.6. S5 command

### 2.6.1. Input of the state setting data (1).

Operation) In the number of SCK pulses at TRANS="H" is 13 or 14, the following operation is executed. The state setting data (1) in the 16-bit shift register is transmitted to the state setting register.

Basic input pattern of S5 command)



### 2.6.2. Input form of the state setting data (1)

**MSB** LSB D15 D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2 D1 D0 B0 Α7 A6 A5 A4 **A3** A2 **A1** A0 **B**1 H0 L0

D15 to D0 is serial-data-inputted at MSB first.

Please input "L" data to D7 to D4.

The state setting data (1) setting

Cotting hit	Outline of command	Input	(Default)		
Setting bit	Outline of confinant	0	1	(Delault)	
A7	Setting of output gain control range	High setting mode 47.5% to 202.7%	Low setting mode 8.46% to 43.96%	47.5% to 202.7%	
A6 to A0	Setting of output gain control data	Please refer to	100%		
B1 to B0	Setting of number of PWM resolution bits	Please refer	to 15 page.	16-bit	
H0	Initialization (≈POR operation)	Not Active	Active	Not Active	
LO	Setting of standby mode (1) function	Not Active	Active	Not Active	



# 2.6.3. Details of each setting

# A setting (setting of output gain control data reference value)

(1). In the case of the high setting mode (A7=0, 47.5% to 202.7%)

( ' ' '			<del>5 0: t.</del>		0011	9	ode (A/	0, 47	.0 /0 6	<u> </u>	1 70)				
A[6]	A[5]	A[4]	A[3]	A[2]	A[1]	A[0]	Current	A[6]	A[5]	A[4]	A[3]	A[2]	A[1]	A[0]	Current
							gain(%)								gain(%)
1	1	1	1	1	1	0	202.7 201.5	0	1	1	1	1	1	0	124.5 123.3
1	1	1	1	1	0	1	200.3	0	1	1	1	1	0	1	123.3
1	1	1	1	1	0	0	199.1	0	1	1	1	1	0	0	120.8
1	1	1	1	0	1	1	197.8	0	1	1	1	0	1	1	119.6
1	1	1	1	0	1	0	196.6	0	1	1	1	0	1	0	118.4
1	1	1	1	0	0	1	195.4	0	1	1	1	0	0	1	117.2
1	1	1	1	0	0	0	194.2	0	1	1	1	0	0	0	115.9
1	1	1	0	1	1	1	193.0	0	1	1	0	1	1	1	114.7
1	1	1	0	1	1	0	191.7	0	1	1	0	1	1	0	113.5
1	1	1	0	1	0	1	190.5	0	1	1	0	1	0	1	112.3
1	1	1	0	0	0	0	189.3 188.1	0	1	1	0	0	0	0	111.0 109.8
1	1	1	0	0	1	0	186.8	0	1	1	0	0	1	0	109.6
1	1	1	0	0	0	1	185.6	0	1	1	0	0	0	1	107.4
1	1	1	0	0	0	0	184.4	0	1	1	0	0	0	0	106.2
1	1	0	1	1	1	1	183.2	0	1	0	1	1	1	1	104.9
1	1	0	1	1	1	0	181.9	0	1	0	1	1	1	0	103.7
1	1	0	1	1	0	1	180.7	0	1	0	1	1	0	1	102.5
1	1	0	1	1	0	0	179.5	0	1	0	1	1	0	0	101.3
1	1	0	1	0	1	1	178.3	0	1	0	1	0	1	1	100.0 (Default)
1	1	0	1	0	1	0	177.1	0	1	0	1	0	1	0	98.8
1	1	0	1	0	0	1	175.8	0	1	0	1	0	0	1	97.6
1	1	0	1	0	0	0	174.6	0	1	0	1	0	0	0	96.4
1	1	0	0	1	1	1	173.4	0	1	0	0	1	1	1	95.2
1	1	0	0	1	1	0	172.2	0	1	0	0	1	1	0	93.9
1	1	0	0	1	0	1	170.9	0	1	0	0	1	0	1	92.7
1	1	0	0	1	0	0	169.7	0	1	0	0	1	0	0	91.5
1	1	0	0	0	1	1	168.5 167.3	0	1	0	0	0	1	1 0	90.3 89.0
1	1	0	0	0	0	1	166.1	0	1	0	0	0	0	1	87.8
1	1	0	0	0	0	0	164.8	0	1	0	0	0	0	0	86.6
1	0	1	1	1	1	1	163.6	0	0	1	1	1	1	1	85.4
1	0	1	1	1	1	0	162.4	0	0	1	1	1	1	0	84.2
1	0	1	1	1	0	1	161.2	0	0	1	1	1	0	1	82.9
1	0	1	1	1	0	0	159.9	0	0	1	1	1	0	0	81.7
1	0	1	1	0	1	1	158.7	0	0	1	1	0	1	1	80.5
1	0	1	1	0	1	0	157.5	0	0	1	1	0	1	0	79.3
1	0	1	1	0	0	0	156.3 155.1	0	0	1	1	0	0	0	78.0 76.8
1	0	1	0	1	1	1	153.1	0	0	1	0	1	1	1	75.6
1	0	1	0	1	1	0	152.6	0	0	1	0	1	1	0	74.4
1	0	1	0	1	0	1	151.4	0	0	1	0	1	0	1	73.2
1	0	1	0	1	0	0	150.2	0	0	1	0	1	0	0	71.9
1	0	1	0	0	1	1	148.9	0	0	1	0	0	1	1	70.7
1	0	1	0	0	1	0	147.7	0	0	1	0	0	1	0	69.5
1	0	1	0	0	0	1	146.5	0	0	1	0	0	0	1	68.3
1	0	1	0	0	0	0	145.3	0	0	1	0	0	0	0	67.0
1	0	0	1	1	1	0	144.1 142.8	0	0	0	1	1	1	0	65.8 64.6
1	0	0	1	1	0	1	142.8	0	0	0	1	1	0	1	63.4
1	0	0	1	1	0	0	141.6	0	0	0	1	1	0	0	62.1
1	0	0	1	0	1	1	139.2	0	0	0	1	0	1	1	60.9
1	0	0	1	0	1	0	137.9	0	0	0	1	0	1	0	59.7
1	0	0	1	0	0	1	136.7	0	0	0	1	0	0	1	58.5
1	0	0	1	0	0	0	135.5	0	0	0	1	0	0	0	57.3
1	0	0	0	1	1	1	134.3	0	0	0	0	1	1	1	56.0
1	0	0	0	1	1	0	133.1	0	0	0	0	1	1	0	54.8
1	0	0	0	1	0	1	131.8	0	0	0	0	1	0	1	53.6
1	0	0	0	0	0 1	1	130.6 129.4	0	0	0	0	0	1	1	52.4 51.1
1	0	0	0	0	1	0	129.4	0	0	0	0	0	1	0	49.9
1	0	0	0	0	0	1	126.9	0	0	0	0	0	0	1	48.7
1	0	0	0	0	0	0	125.7	0	0	0	0	0	0	0	47.5
					•			-			•	•			·



(2). In the case of the low setting mode (A7=1, 8.46% to 43.96%)

									0 /0 tO						
A[6]	A[5]	A[4]	A[3]	A[2]	A[1]	A[0]	Current	A[6]	A[5]	A[4]	A[3]	A[2]	A[1]	A[0]	Current
							gain(%)								gain(%)
1	1	1	1	1	1	1	43.96	0	1	1	1	1	1	1	26.07
1	1	1	1	1	1	0	43.68	0	1	1	1	1	1	0	25.79
1	1	1	1	1	0	1	43.40	0	1	1	1	1	0	1	25.51
1	1	1	1	1	0	0	43.12	0	1	1	1	1	0	0	25.23
1	1	1	1	0	1	1	42.84	0	1	1	1	0	1	1	24.95
1	1	1	1	0	1	0	42.56	0	1	1	1	0	1	0	24.67
1	1	1	1	0	0	1	42.28	0	1	1	1	0	0	1	24.39
1	1	1	1	0	0	0	42.00	0	1	1	1	0	0	0	24.11
1	1	1	0	1	1	1	41.72	0	1	1	0	1	1	1	23.83
1	1	1	0	1	1	0	41.44	0	1	1	0	1	1	0	23.55
1	1	1	0	1	0	1	41.16	0	1	1	0	1	0	1	23.27
1	1	1	0	1	0	0	40.89	0	1	1	0	1	0	0	23.00
1	1	1	0	0	1	1	40.61	0	1	1	0	0	1	1	22.72
1	1	1	0	0	1	0	40.33	0	1	1	0	0	1	0	22.44
1	1	1	0	0	0	1	40.05	0	1	1	0	0	0	1	22.16
1	1	1	0	0	0	0	39.77	0	1	1	0	0	0	0	21.88
1	1	0	1	1	1	1	39.49	0	1	0	1	1	1	1	21.60
1	1	0	1	1	1	0	39.21	0	1	0	1	1	1	0	21.32
1	1	0	1	1	0	1	38.93	0	1	0	1	1	0	1	21.04
1	1	0	1	1	0	0	38.65	0	1	0	1	1	0	0	20.76
1	1	0	1	0	1	1	38.37	0	1	0	1	0	1	1	20.48
1	1	0	1	0	1	0	38.09	0	1	0	1	0	1	0	20.20
1	1	0	1	0	0	1	37.81	0	1	0	1	0	0	1	19.92
1	1	0	1	0	0	0	37.53	0	1	0	1	0	0	0	19.64
1	1	0	0	1	1	1	37.25	0	1	0	0	1	1	1	19.36
1	1	0	0	1	1	0	36.97	0	1	0	0	1	1	0	19.08
1	1	0	0	1	0	1	36.69	0	1	0	0	1	0	1	18.80
1	1	0	0	1	0	0	36.41	0	1	0	0	1	0	0	18.52
1	1	0	0	0	1	1	36.13	0	1	0	0	0	1	1	18.24
1	1	0	0	0	1	0	35.85	0	1	0	0	0	1	0	17.96
1	1	0	0	0	0	1	35.57	0	1	0	0	0	0	1	17.68
1	1	0	0	0	0	0	35.29	0	1	0	0	0	0	0	17.40
1	0	1	1	1	1	1	35.02	0	0	1	1	1	1	1	17.13
1	0	1	1	1	1	0	34.74	0	0	1	1	1	1	0	16.85
	0		1	1	0	1	34.74	0	0	1	1	1	0	1	16.57
1		1													
1	0	1	1	1	0	0	34.18	0	0	1	1	1	0	0	16.29
1	0	1	1	0	1	1	33.90	0	0	1	1	0	1	1	16.01
1	0	1	1	0	1	0	33.62	0	0	1	1	0	1	0	15.73
1	0	1	1	0	0	1	33.34	0	0	1	1	0	0	1	15.45
1	0	1	1	0	0	0	33.06	0	0	1	1	0	0	0	15.17
1	0	1	0	1	1	1	32.78	0	0	1	0	1	1	1	14.89
1	0	1	0	1	1	0	32.50	0	0	1	0	1	1	0	14.61
1	0	1	0	1	0	1	32.22	0	0	1	0	1	0	1	14.33
1	0	1	0	1	0	0	31.94	0	0	1	0	1	0	0	14.05
1	0	1	0	0	1	1	31.66	0	0	1	0	0	1	1	13.77
1	0	1	0	0	1	0	31.38	0	0	1	0	0	1	0	13.49
1	0	1	0	0	0	1	31.10	0	0	1	0	0	0	1	13.21
1	0	1	0	0	0	0	30.82	0	0	1	0	0	0	0	12.93
1	0	0	1	1	1	1	30.54	0	0	0	1	1	1	1	12.65
1	0	0	1	1	1	0	30.26	0	0	0	1	1	1	0	12.37
1	0	0	1	1	0	1	29.98	0	0	0	1	1	0	1	12.09
1	0	0	1	1	0	0	29.70	0	0	0	1	1	0	0	11.81
1	0	0	1	0	1	1	29.42	0	0	0	1	0	1	1	11.53
1	0	0	1	0	1	0	29.42	0	0	0	1	0	1	0	11.33
1	0	0	1	0	0	1	28.87	0	0	0	1	0	0	1	10.98
1	0	0	1	0	0	0	28.59	0	0	0	1	0	0	0	10.70
1	0	0	0	1	1	1	28.31	0	0	0	0	1	1	1	10.42
1	0	0	0	1	1	0	28.03	0	0	0	0	1	1	0	10.14
1	0	0	0	1	0	1	27.75	0	0	0	0	1	0	1	9.86
1	0	0	0	1	0	0	27.47	0	0	0	0	1	0	0	9.58
1	0	0	0	0	1	1	27.19	0	0	0	0	0	1	1	9.30
1	0	0	0	0	1	0	26.91	0	0	0	0	0	1	0	9.02
1	0	0	0	0	0	1	26.63	0	0	0	0	0	0	1	8.74
	0	0	0	0	0	0	26.35	0	0	0	0	0	0	0	8.46



**B** setting (Setting of PWM resolution)

B[1]	B[0]	Setting
0	0	16-bit (65536 steps) setting. (Default)
0	1	14-bit (16384 steps) setting.
1	0	12-bit (4096 steps) setting.
1	1	10-bit (1024 steps) setting.

H setting (Setting of Initialization function)

H[0]	Setting
0	The initialization function becomes not active (Default) It's normal operation mode.
1	The initialization function becomes active. All data in IC is initialized. After data initialization, it becomes normal operation mode.

# L setting (Setting of standby mode (1) function)

L[0]	Setting
0	The standby mode (1) function becomes not active. (Default) It's normal operation mode.
1	The standby mode (1) function becomes active.  The circuits other than the logic circuit are turned off. And power supply current is reduced.  (All the data of the IC are stored. Data input is possible.)  When S0 command is inputted at the standby mode (1), IC returns to normal operation mode.  Return time to the normal operation mode is about 30 µs.

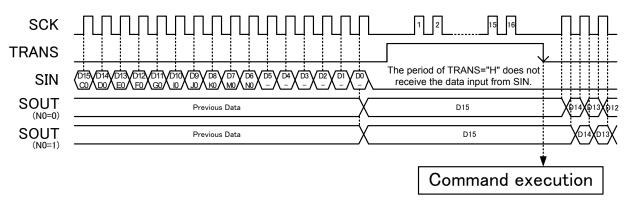


#### 2.7. S6 command

### 2.7.1. Input of the state setting data (2).

Operation) In the number of SCK pulses at TRANS="H" is 15 or 16, the following operation is executed. The state setting data (2) in the 16-bit shift register is transmitted to the state setting register.

Basic input pattern of S6 command)



### 2.7.2. Input form of the state setting data (2)

**MSB** LSB D15 D14 D13 D12 D10 D8 D7 D6 D5 D4 D3 D2 D11 D9 D1 D0 E0 F0 Μ0 N0 C0 D0 G0 10 J0 K0

# The state setting data (2) setting

Setting		Inpu	t data	D ( )
bit	Outline of command	0	1	Default
C0	Setting of thermal shutdown function (TSD)	Active	Not Active	Active
D0	Setting of PWMCLK open detection function (POD)	Active	Not Active	Active
E0	Setting of output open detection function (OOD)	Not Active	Active	Not Active
F0	Setting of output short detection function (OSD)	Not Active	Active	Not Active
G0	Setting of PWM output synchronization	Synchronous	Asynchronous	Synchronous
10	Setting of PWM output system	Normal output	Division output	Normal output
JO	Setting of standby mode (2) function This function becomes active only at the time of the 16-bit PWM setting.	Not Active	Active	Not Active
K0	Setting of output short detection voltage	Vosd1	Vosd2	Vosd1
M0	Setting of output delay function	Active	Not Active	Active
N0	Setting of SCK trigger of SOUT	Up edge trigger mode	Down edge trigger mode	Up edge trigger mode

16

<sup>\*</sup> D15 to D0 is serial-data-inputted at MSB first.

<sup>\*</sup> Please input "L" data to D5 to D0.



### 2.7.3. Details of each setting

C setting (Setting of thermal shutdown function (TSD))

C[0]	Setting
0	Thermal shutdown function becomes active. (Default)
1	Thermal shutdown function becomes not active.

D setting (Setting of PWMCLK open detection function (POD))

D[0]	Setting
0	PWMCLK open detection function becomes active. (Default) When it was the state that a PWMCLK signal isn't input by breaking of wiring, it's the function which prevents PWM output keeping stopping by on state. When PWMCLK is not inputted for about 1 second after it is inputted even once, all output is turned off compulsorily. Output compulsion off is released by the initialization function of S5 command. In addition, the output compulsion off is removed by inputting PWMCLK again.
1	PWMCLK open detection function becomes not active.

E setting (Setting of output open detection function (OOD))

E[0]	Setting								
0	Output open detection function becomes not active. (Default)								
1	Output open detection function becomes active.								

F setting (Setting of output short detection function (OSD))

F[0]	Setting				
0	Output short detection function becomes not active. (Default)				
1	Output short detection function becomes active.				

**G** setting (Setting of PWM output synchronization)

G[0]	Setting			
0	PWM output synchronous mode. (Default)			
1	PWM output asynchronous mode.			

# I setting (Setting of PWM output system)

I[0]	Setting
0	Normal PWM output mode. (Default)
1	Division PWM output mode.



J setting (Setting of standby mode (2))

J[0]	Setting
0	The standby mode (2) function becomes not active. (Default) It's normal operation mode.
1	The standby mode (2) function becomes active.  A state changes according to the data in a PWM data register.  Condition 1: All data in the PWM data register1 and the PWM data register3 are "L".  It becomes standby mode (2).  The circuits other than the logic circuit are turned off. And power supply current is reduced.  (All the data of the IC are stored. Data input is possible.)  Condition 2: Excluding condition 1.  It becomes Pre standby mode.  It is the same operation as normal operation mode.  Return time from standby mode (2) to Pre standby mode is about 30 µs.  This function becomes active only at the time of the 16-bit PWM setting.

K setting (Setting of output short detection voltage)

K[0]	Setting
0	V <sub>OSD1</sub> setting. (Default)
1	V <sub>OSD2</sub> setting.

M setting (Setting of output delay function)

M[0]	Setting				
0	Output delay function becomes active. (Default)				
1	Output delay function becomes not active.				

N setting (Setting of SCK trigger of SOUT)

N[0]	Setting			
0	It becomes up edge trigger mode. (Default) Data output trigger from SOUT, becomes up edge of SCK			
1	It becomes down edge trigger mode.  Data output trigger from SOUT, becomes down edge of SCK			



### 3. Input of PWM setting data

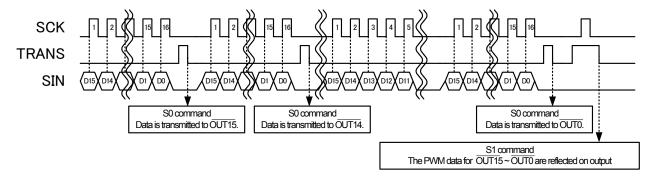
### 3.1. Normal input mode (S0 command: 16 times)

It commands the PWM data input only.

The PWM data for  $\overline{\text{OUT0}}$  to  $\overline{\text{OUT15}}$  are transferred to the PWM data resister by repeating the PWM data input to the 16-bit shift register and S0 command input 16 times.

Unless S1 command is input, the PWM data for  $\overline{\text{OUT0}}$  to  $\overline{\text{OUT15}}$  is not reflected on output.

#### Normal input mode) S0 command 16 times



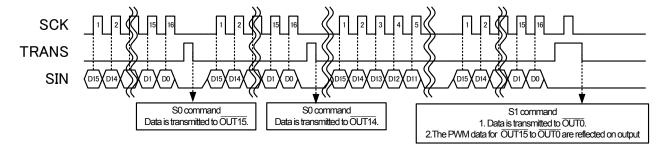
### 3.2. Speed input mode (S0 command 15 times + S1 command once)

It commands PWM data input and reflecting the PWM data on output at the same time.

The PWM data for OUT0 to OUT15 are reflected in the output by inputting S1 command after repeating the PWM data input to the 16-bit shift register and S0 command input 15 times.

Normal input mode should be used to input PWM data only.

#### Speed input mode) S0 command 15 times + S1 command once



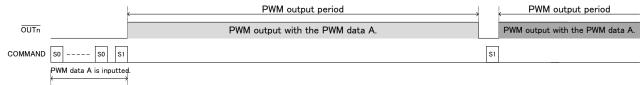


### 4. About operation of a PWM output

The PWM output is outputted once to one S1 command.

		PWM output period	
OUTn		PWM output with the PWM data A.	
COMMAND	S0 S0 S1		
	PWM data A is inputted	ı	

When doing PWM output once again, it's necessary to input S1 command.



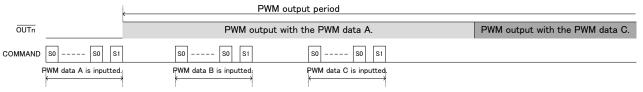
When S1 command is inputted during a PWM output in PWM output asynchronous mode, the present PWM output is canceled and a PWM output is immediately started by new PWM data.

		<del>-</del>	PWM output period			
OUTn		PWM output with the PWM data A.	PWM output with the PWM data B.			
COMMAND	S0 S0 S1	S0 S0 S1				
	PWM data A is inputted	PWM data B is inputted.				

When S1 command is inputted during a PWM output in PWM output synchronous mode, after the present PWM output has ended, a PWM output is started by new PWM data.

	Ļ	PWM output period				
OUTn		PWM output with the PWM data A. PWM output with the PWM data				
COMMAND S0 S0	S1 S0	·- S0 S1				
PWM data A is inp	utted PWM data	B is inputted				

If S1 command is inputted two or more times during a PWM output in PWM output synchronous mode, after the present PWM output has ended, a PWM output will be started by the PWM data inputted at the end.

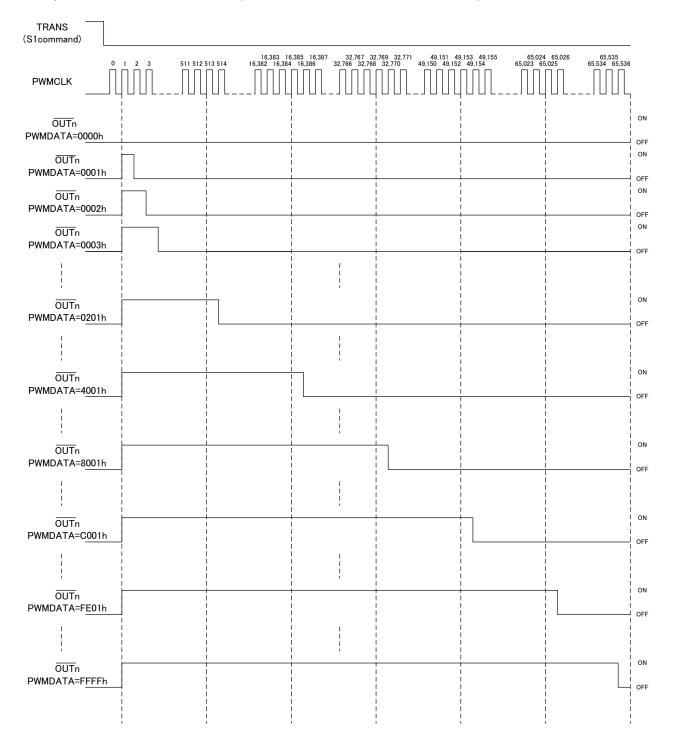




### 5. PWM Output

# 5.1. Normal PWM output mode.

Output waveform of 16-bit PWM. (OUTn indicates a current waveform.)



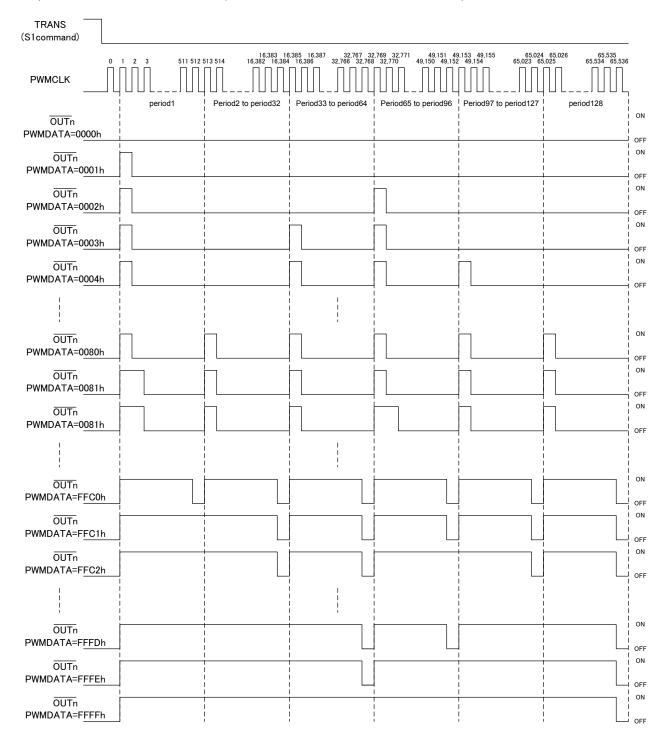


### 5.2. Division PWM output mode.

PWM output period is divided into 128 pieces.

Because turn on time of output is not biased, it is effective in the flicker prevention on the display.

Output waveform of 16-bit PWM. (**OUTn** indicates a current waveform.)





### 6. Thermal shutdown circuit (TSD)

When the temperature of internal IC exceeds 150°C, all constant current outputs are turned off by this function. The constant current is outputted again when the temperature decreases to the rating.

The thermal shutdown function of this IC aims at stopping the influence (emitting smoke, ignition) on the circumference (LED and PCB) to the minimum, when it is used on the conditions beyond not a function but the maximum rating for preventing destruction of IC and IC results in destruction.

#### Calculation of heat

Take care not to let the temperature of the internal IC exceed 150°C by referring to the formula below.

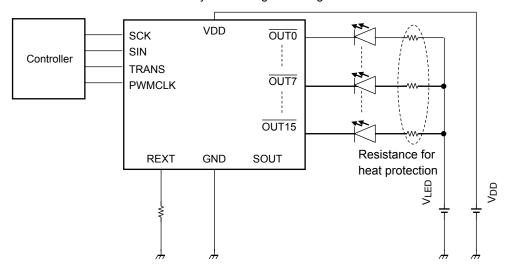
Consumption power (IC output) [W] = (LED supply voltage [V] - Minimum of  $V_f$  of LED [V] ) × Output current [A] × number of output × (ON Duty [%] / 100 ) Consumption power (IC supply) [W] = IC supply voltage [V] ×IC supply current [A] Total of consumption power [W] = Consumption power (IC output) [W] + Consumption power (IC supply) [W]

Heat value of internal IC [°C] = Thermal Resistance [°C / W] × total of consumption power [W]

Temperature of internal IC [°C] = Heat value of internal IC [°C] + Ambient temperature [°C]

#### In case used LED supply voltage is high, and heat value of internal IC is large.

Heat value of internal IC can be reduced by decreasing the voltage with the external resistance shown below.



#### Setting method of resistance for heat protection

Voltage that should decrease by external resistance [V]

= LED supply voltage [V] - maximum of Vf of LED [V] - Output voltage [V]

Resistance for heat protection  $[\Omega]$  = Voltage that should decrease by external resistance [V] / Output current [A]

#### 7. Output delay function

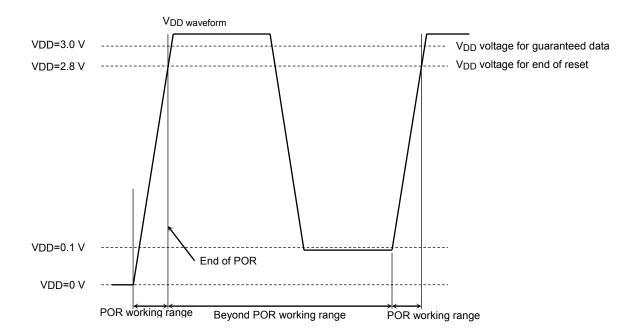
This function is intended to have the effect of reducing switching noise by reducing the di/dt when all outputs are ON or OFF at the same time. There is a switching time lag between outputs. (tdly (ON), tdly (OFF)). A switching time lag between outputs is put in order of the following.

$$\overline{OUT0} \to \overline{OUT15} \to \overline{OUT7} \to \overline{OUT8} \to \overline{OUT1} \to \overline{OUT14} \to \overline{OUT6} \to \overline{OUT9} \to \overline{OUT2} \to \overline{OUT13} \to \overline{OUT15} \to \overline{OUT10} \to \overline{OUT13} \to \overline{OUT12} \to \overline{OUT14} \to \overline{OUT11}$$



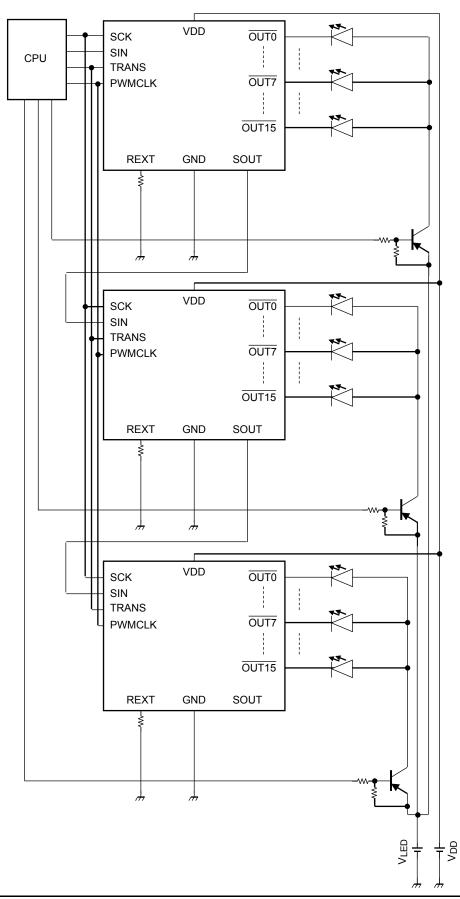
### 8. Power on reset (POR)

It avoids the malfunction by resetting all internal data of IC and setting default in startup. POR circuit operates only when  $V_{DD}$  rises from 0 V. To restart POR,  $V_{DD}$  should be 0.1 V or less. As for the voltage of storing the internal data, it is guaranteed after  $V_{DD}$  reaches 3.0 V or more once.





# 9. Application circuit (Dynamic lighting)





Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating (Note1)	Unit
Supply voltage	$V_{DD}$	- 0.3 to 6.0	V
Output current	lout	95	mA
Logic input voltage	V <sub>IN</sub>	- 0.3 to V <sub>DD</sub> + 0.3 (Note2)	V
Output voltage	V <sub>OUT</sub>	- 0.3 to 17	V
Operating temperature	T <sub>opr</sub>	- 40 to 85	°C
Storage temperature	T <sub>stg</sub>	- 55 to 150	°C
Thermal resistance	R <sub>th(j-a)</sub>	45.47 (Note3)	°C/W
Power dissipation	P <sub>D</sub>	2.74 (Note3)	W

Note1: Voltage is ground referenced.

Note2: 6 V must not be exceeded.

Note3: When ambient temperature is Ta = 25°C or more. Every time ambient temperature exceeded 1°C, please decrease 1/Rth(j-a).

# **Operating Condition**

DC Characteristics (Unless otherwise noted,  $V_{DD}$  = 3.0 V to 5.5 V,  $T_a$  = -40 to 85 °C)

Characteristics	Symbol	Test Conditions	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$	_	3.0	_	5.5	V
High level logic input voltage	ViH	Test terminal is SIN, SCK, TRANS, PWMCLK	0.7 × V <sub>DD</sub>	_	V <sub>DD</sub>	٧
Low level logic input voltage	V <sub>IL</sub>	Test terminal is SIN, SCK, TRANS, PWMCLK	GND	_	0.3 × V <sub>DD</sub>	V
High level SOUT output current	I <sub>OH</sub>	_	_	_	- 1	mA
Low level SOUT output current	l <sub>OL</sub>	_	_	_	1	mA
Constant current output	lout	Test terminal is OUTn	1.5	_	90	mA



AC Characteristics 1 (Unless otherwise noted,  $V_{DD} = 5.0 \text{ V}$ ,  $T_a = 25 ^{\circ}\text{C}$ )

Characteristics	Symbol	Test Conditions			Тур.	Max	Unit
Serial data transfer frequency	foor	Up edge trigger mode  Cascade connect		_	_	30	MHz
	fsck	Down edge trigger mode	Cascade connect	_	_	25	IVII IZ
SCK pulse width	twsck	SCK="H" and "L"		15	20	_	ns
PWMCLK pulse width	t <sub>wPWM</sub>	PWM="H" and "L" , R <sub>EXT</sub>	=200 Ω to 12 kΩ	15	20	_	ns
TRANS pulse width	t <sub>wTRANS</sub>	TRANS="H"		20	_	_	ns
	tsetup1	SIN-SCK	1	_	_		
	t <sub>SETUP2</sub>	TRANS-SCK	5	_	_	ns	
Serial data setup time	t <sub>SETUP3</sub>	TRANS-SCK	5	_	_		
	tsetup4	TRANS-SCK	2	_	_		
	t <sub>SETUP5</sub>	TRANS-PWMCLK	5	_	_		
	t <sub>HOLD1</sub>	SIN-SCK	3	_	_		
	t <sub>HOLD2</sub>	TRANS-SCK	7	_	_		
Serial data hold time	t <sub>HOLD3</sub>	TRANS-SCK	7	_	_	ns	
	t <sub>HOLD4</sub>	TRANS-SCK	2	_	_	1	
	t <sub>HOLD5</sub>	TRANS-PWMCLK	5	_	_		

AC Characteristics 2 (Unless otherwise noted, V<sub>DD</sub> = 3.3 V, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Conditions			Тур.	Max	Unit
Carial data transfer frequency	faar	Up edge trigger mode	Cascade connect	_	_	30	MHz
Serial data transfer frequency	fsck	Down edge trigger mode	Cascade connect	_	_	25	IVITZ
SCK pulse width	twsck	SCK="H" and "L"		15	20	_	ns
PWMCLK pulse width	t <sub>wPWM</sub>	PWM="H" and "L", REXT	=200 Ω to 12 kΩ	15	20	_	ns
TRANS pulse width	twtrans	TRANS="H"		20	_	_	ns
	tsetup1	SIN-SCK	1	_	_	ns	
	t <sub>SETUP2</sub>	TRANS-SCK	5	_	_		
Serial data setup time	t <sub>SETUP3</sub>	TRANS-SCK	5	_	_		
	t <sub>SETUP4</sub>	TRANS-SCK	2	_	_		
	tsetup5	TRANS-PWMCLK	5	_	_		
	t <sub>HOLD1</sub>	SIN-SCK	3	_	_		
	t <sub>HOLD2</sub>	TRANS-SCK	7	_	_		
Serial data hold time	t <sub>HOLD3</sub>	TRANS-SCK	7	_	_	ns	
	t <sub>HOLD4</sub>	TRANS-SCK	2	_	_		
	t <sub>HOLD5</sub>	TRANS-PWMCLK	5	_	_		



### **Electrical Characteristics**

Electrical Characteristics 1 (Unless otherwise noted,  $V_{DD}$  = 5.0 V,  $T_a$  = 25 °C)

Characteristics	Symbol	Test Circuit	Test Conditions		Min	Тур.	Max	Unit
High level SOUT output voltage	Vон	1	T <sub>a</sub> =-40 to +85°C	I <sub>OH</sub> =-1 mA	V <sub>DD</sub> - 0.3	_	V <sub>DD</sub>	٧
L o w l e v e l SOUT output voltage	$V_{OL}$	1	1 <sub>a</sub> 40 to +65 C	I <sub>OL</sub> =+1 mA	GND		0.3	V
High level logic input current	Iн	2	V <sub>IN</sub> = V <sub>DD</sub> Test terminal is SIN,	SCK	_		1	μΑ
Low level logic input current	lıL	3	V <sub>IN</sub> = GND Test terminal is PWMCLK, SIN, SCI	K, TRANS	_	_	-1	μA
	I <sub>DD1</sub>	4	Stand-by mode (1) o	. ,	_	_	1.0	μA
Power supply current	I <sub>DD2</sub>	4	V <sub>OUT</sub> =1.0 V, R <sub>EXT</sub> =1	1.2 kΩ	_	_	7.0	mA
Constant current error(IC to IC) (S rank)	Δl <sub>OUT(IC)</sub>	5	$V_{OUT}$ =1.0 V, R <sub>EXT</sub> =1.2 kΩ $\overline{OUT0}$ to $\overline{OUT15}$ , 1ch output on		_	±1.0	±1.5	%
Constant current error(Ch to Ch) (S rank)	Δl <sub>OUT(Ch)</sub>	5	$V_{OUT}$ =1.0 V, R <sub>EXT</sub> =1.2 kΩ $\overline{OUT0}$ to $\overline{OUT15}$ , 1ch output on		_	±1.0	±1.5	%
Constant current error(IC to IC) (N rank)	Δl <sub>OUT(IC)</sub>	5	$V_{OUT}$ =1.0 V, R <sub>EXT</sub> =1.2 kΩ $\overline{OUT0}$ to $\overline{OUT15}$ , 1ch output on		_	±1.0	±2.5	%
Constant current error(Ch to Ch) (N rank)	Δl <sub>OUT(Ch)</sub>	5	$V_{OUT}$ =1.0 V, R <sub>EXT</sub> =1.2 kΩ OUT0 to OUT15, 1ch output on		_	±1.0	±2.5	%
Output OFF leak current	lok	5	V <sub>OUT</sub> =17 V, R <sub>EXT</sub> =1.2 kΩ, OUTn off		_	_	0.5	μΑ
Constant current output power supply voltage dependence	%V <sub>DD</sub>	5	$V_{DD}$ =4.5 to 5.5 V, $V_{OUT}$ =1.0 V $R_{EXT}$ =1.2 kΩ OUT0 to $OUT15$ , 1ch output on		_	±1	±5	%/V
Constant current output output voltage dependence	%V <sub>OUT</sub>	5	$V_{OUT}$ =1.0 to 3.0 V, R <sub>EXT</sub> =1.2 kΩ $\overline{OUT0}$ to $\overline{OUT15}$ , 1ch output on		_	±0.1	±0.5	%/V
Pull-down resistor	R <sub>DOWN</sub>	2	Test terminal is TRANS, PWMCLK		250	500	750	kΩ
OOD voltage	V <sub>OOD</sub>	6	R <sub>EXT</sub> =200 Ω to 12 k	Ω	0.2	0.3	0.4	V
	V <sub>OSD1</sub>	6	R <sub>EXT</sub> =200 $\Omega$ to 12 k	Ω	V <sub>DD</sub> - 1.3	V <sub>DD</sub> - 1.4	V <sub>DD</sub> - 1.5	
OSD voltage	V <sub>OSD2</sub>	6	R <sub>EXT</sub> =200 Ω to 12 k	Ω	0.5 × V <sub>DD</sub>	0.525 × V <sub>DD</sub>	0.55 × V <sub>DD</sub>	٧
TSD start temperature	T <sub>TSD(ON)</sub>	_	Junction temperature		150	_	_	°C
TSD release temperature	T <sub>TSD(OFF)</sub>	_	Junction temperatur	e	100	_	_	°C



Electrical Characteristics 2 (Unless otherwise noted, V<sub>DD</sub> = 3.3 V, T<sub>a</sub> = 25 °C)

Electrical Characteristic	CS Z (UIII	1622 Oti	nerwise noteu, vi	DD - 3.3 V, Ia	<u> </u>	<u>)                                    </u>		
Characteristics	Symbol	Test Circuit	Test Conditions		Min	Тур.	Max	Unit
H i g h l e v e l SOUT output voltage	Vон	1	T <sub>a</sub> =-40 to +85°C	I <sub>OH</sub> =-1 mA	V <sub>DD</sub> - 0.3	_	$V_{DD}$	٧
L o w l e v e l SOUT output voltage	V <sub>OL</sub>	1	17a40 to 103 C	I <sub>OL</sub> =+1 mA	GND	_	0.3	V
High level logic input current	Iн	2	V <sub>IN</sub> = V <sub>DD</sub> Test terminal is SIN, SC	CK	_	_	1	μΑ
Low level logic input current	lıL	3	V <sub>IN</sub> = GND Test terminal is PWMCLK, SIN, SCK, T	RANS	_	_	-1	μA
Dawas analy analy	I <sub>DD1</sub>	4	Stand-by mode (1) or (2 V <sub>OUT</sub> =17 V, SCK="L""	2)	_	_	1.0	μA
Power supply current	I <sub>DD2</sub>	4	V <sub>OUT</sub> =1.0 V, R <sub>EXT</sub> =1.2 I All output off	<b>ς</b> Ω	_	_	7.0	mA
Constant current error(IC to IC) (S rank)	Δl <sub>OUT(IC)</sub>	5	V <sub>OUT</sub> =1.0 V, R <sub>EXT</sub> =1.2 kΩ OUT0 to OUT15 , 1ch output on		_	±1.0	±1.5	%
Constant current error(Ch to Ch) (S rank)	Δl <sub>OUT(Ch)</sub>	5	V <sub>OUT</sub> =1.0 V, R <sub>EXT</sub> =1.2 kΩ OUT0 to OUT15 , 1ch output on		_	±1.0	±1.5	%
Constant current error(IC to IC) (N rank)	ΔΙουτ(ΙC)	5	$V_{OUT}$ =1.0 V, R <sub>EXT</sub> =1.2 kΩ $\overline{OUT0}$ to $\overline{OUT15}$ , 1ch output on		_	±1.0	±2.5	%
Constant current error(Ch to Ch) (N rank)	Δl <sub>OUT(Ch)</sub>	5	V <sub>OUT</sub> =1.0 V, R <sub>EXT</sub> =1.2 kΩ OUT0 to OUT15 , 1ch output on		_	±1.0	±2.5	%
Output OFF leak current	lok	5	V <sub>OUT</sub> =17 V, R <sub>EXT</sub> =1.2 kΩ, OUTn off		_	_	0.5	μΑ
Constant current output power supply voltage dependence	%V <sub>DD</sub>	5	V <sub>DD</sub> =3.0 to 3.6 V, V <sub>OUT</sub> =1.0 V R <sub>EXT</sub> =1.2 kΩ OUT0 to OUT15 , 1ch output on		_	±1	±5	%/V
Constant current output output voltage dependence	%V <sub>OUT</sub>	5	$V_{OUT}$ =1.0 to 3.0 V, R <sub>EXT</sub> =1.2 kΩ $\overline{OUT0}$ to $\overline{OUT15}$ , 1ch output on		_	±0.1	±0.5	%/V
Pull-down resistor	R <sub>DOWN</sub>	2	Test terminal is TRANS, PWMCLK		250	500	750	kΩ
OOD voltage	V <sub>OOD</sub>	6	$R_{EXT}$ =200 $\Omega$ to 12 $k\Omega$		0.2	0.3	0.4	V
	V <sub>OSD1</sub>	6	R <sub>EXT</sub> =200 $\Omega$ to 12 k $\Omega$		V <sub>DD</sub> - 1.3	V <sub>DD</sub> - 1.4	V <sub>DD</sub> - 1.5	
OSD voltage	V <sub>OSD2</sub>	6	R <sub>EXT</sub> =200 Ω to 12 k Ω		0.5 × V <sub>DD</sub>	0.525 × V <sub>DD</sub>	0.55 × V <sub>DD</sub>	٧
TSD start temperature	T <sub>TSD(ON)</sub>	_	Junction temperature		150	_	_	°C
TSD release temperature	T <sub>TSD(OFF)</sub>		Junction temperature		100	_	_	°C



# **Switching Characteristics**

Switching Characteristics 1 (Unless otherwise specified,  $V_{DD}$  = 5.0 V,  $T_a$  = 25 °C)

Cha	aracteristics	Symbol	Test Circuit	Test Conditions	Min	Тур.	Max	Unit
	SCK↑ to SOUT	t <sub>PD1U</sub>	7	Up edge trigger mode	6	16	30	
Propagation d e I a v	I SCK+ to SOUT	t <sub>PD1D</sub>	7	Down edge trigger mode	2	10	14	ns
u c i a y	PWMCLK to OUT0	t <sub>PD2</sub>	7	REXT=1.2 kΩ	_	30	40	
Constant r i s e	current Output e t i m e	t <sub>or</sub>	7	10 to 90% at voltage waveform of OUTn R <sub>EXT</sub> =1.2 kΩ	_	10	20	ns
Constant f a I	current Output t i m e	t <sub>of</sub>	7	90 to 10% at voltage waveform of OUTn R <sub>EXT</sub> =1.2 kΩ	-	10	20	ns
Constant	current Output	t <sub>DLY(ON)</sub>	7	REXT=1.2 kΩ	1	4	9	ns
d e I a	y time	t <sub>DLY(OFF)</sub>	7	R <sub>EXT</sub> =1.2 kΩ	1	4	9	ns

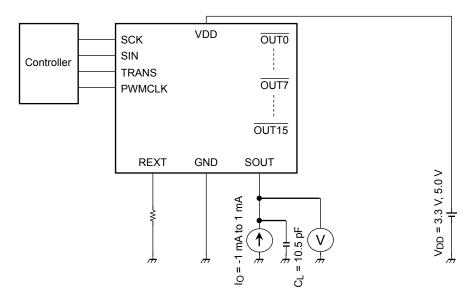
Switching Characteristics 2 (Unless otherwise specified, V<sub>DD</sub> = 3.3 V, T<sub>a</sub> = 25 °C)

Cha	aracteristics	Symbol	Test Circuit	Test Conditions	Min	Тур.	Max	Unit
_	SCK↑ to SOUT	t <sub>PD1U</sub>	7	Up edge trigger mode	6	16	30	
Propagation d e I a v	SCK↓ to SOUT	t <sub>PD1D</sub>	7	Down edge trigger mode	2	13	18	ns
u c i a y	PWMCLK to OUT0	t <sub>PD2</sub>	7	REXT=1.2 kΩ	_	30	40	
Constant r i s e	current Output e t i m e	t <sub>or</sub>	7	10 to 90% at voltage waveform of OUTn R <sub>EXT</sub> =1.2 kΩ	_	10	20	ns
Constant f a l	current Output t i m e	t <sub>of</sub>	7	90 to 10% at voltage waveform of OUTn R <sub>EXT</sub> =1.2 kΩ	_	10	20	ns
Constant curre	current Output	t <sub>DLY(ON)</sub>	7	REXT=1.2 kΩ	2	6	12	ns
d e I a	y time	t <sub>DLY(OFF)</sub>	7	R <sub>EXT</sub> =1.2 kΩ	2	6	12	ns

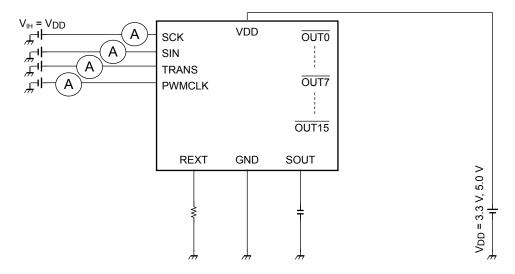


#### **Test circuit**

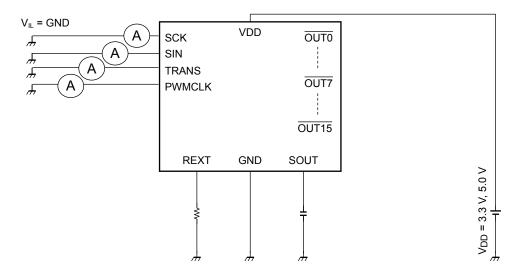
Test circuit 1: High level SOUT output voltage / Low level SOUT output voltage



Test circuit 2: High level logic input current / Pull-down resistance

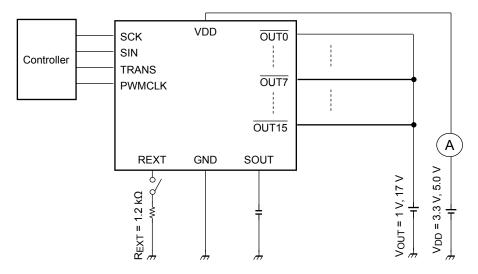


Test circuit 3: Low level logic input current

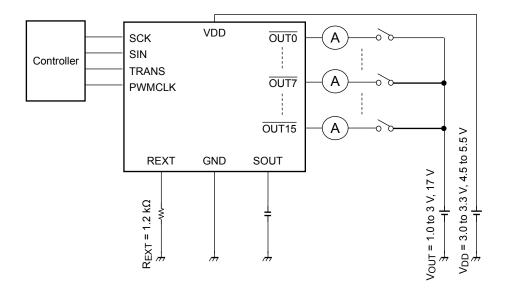




Test circuit 4: Power supply current

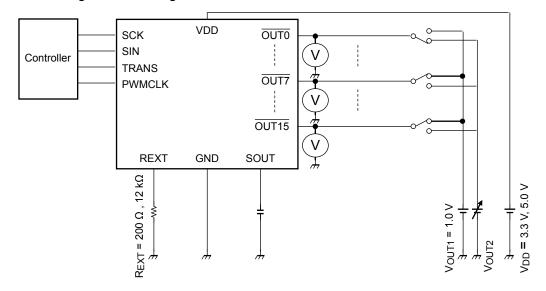


Test circuit 5 : Constant current error(IC to IC and Ch to Ch) / Output OFF leak current / Constant current output power supply voltage dependence / Constant current output voltage dependence



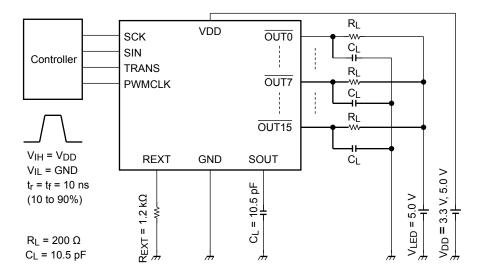


Test Circuit 6 : OOD voltage / OSD voltage



All output is set to turning on. Only one output is connected with the  $V_{OUT2}$  power supply, and other outputs are connected with the  $V_{OUT1}$  power supply.  $V_{OUT2}$  is changed and OOD voltage / OSD voltage is checked in the error detection result from each output terminal voltage and SOUT.

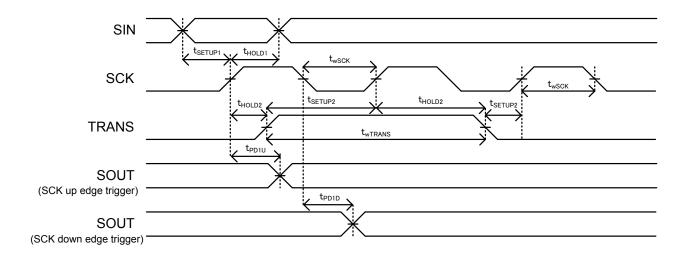
Test Circuit 7: Switching Characteristics

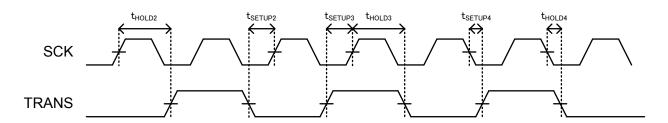




### **Timing waveform**

# (1). SCK, TRANS, SIN, SOUT





When changing TRANS, please do it when SCK is "L".

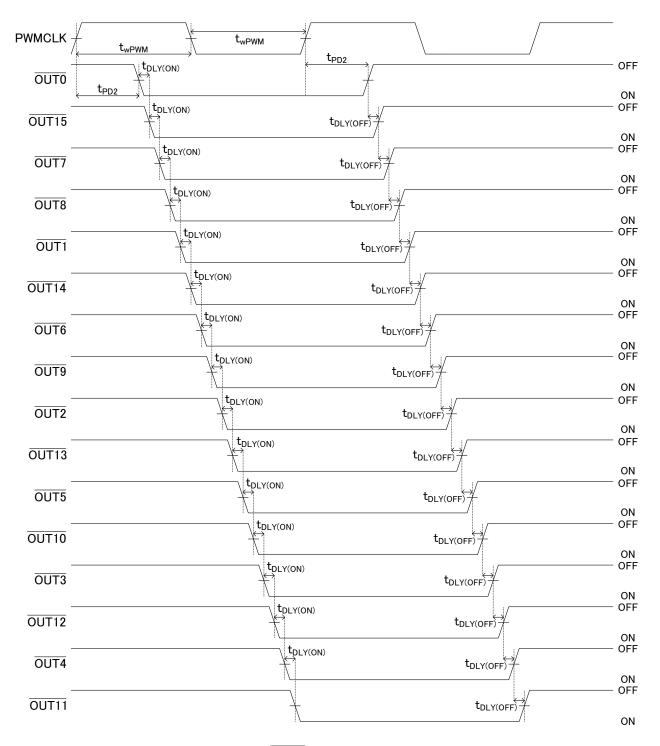
# (2). OUTn



OUTn is a voltage waveform.



# (3). PWMCLK, OUT0 to OUT15



OUTn is a voltage waveform.

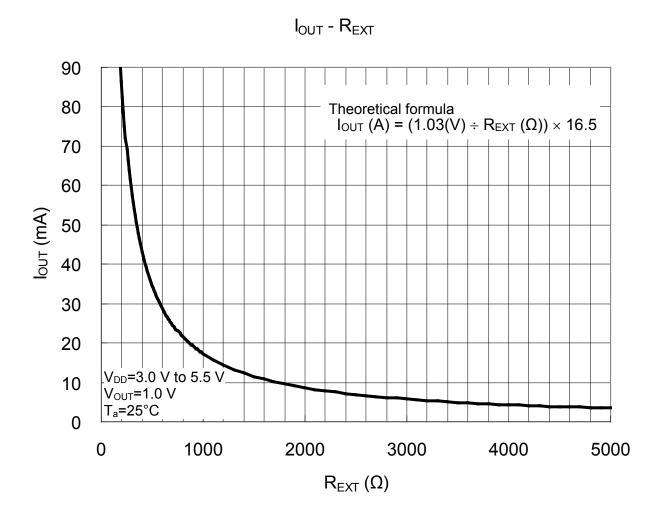


#### Reference data

This data is provided for reference only. So, in designing for mass production, take enough care in evaluating IC operation.

## Output Current (I<sub>OUT</sub>) - Constant current output setting resistance (R<sub>EXT</sub>)

The output gain control data is default.

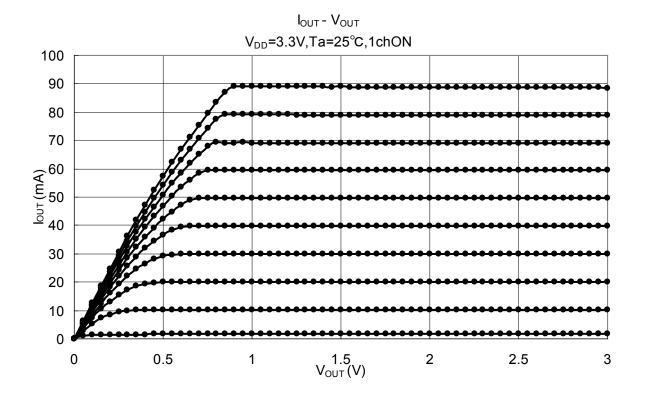


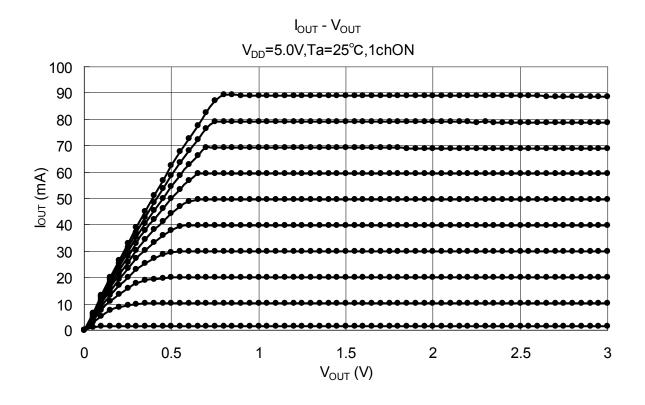


### Reference data

This data is provided for reference only. So, in designing for mass production, take enough care in evaluating IC operation.

# Output current (I<sub>OUT</sub>) - Output voltage (V<sub>OUT</sub>)







#### Notes on design of ICs

# 1. Regarding decoupling capacitor between power supply and GND

It is recommended that decoupling capacitor between power supply and GND should place as near IC as possible.

#### 2. Regarding resistors for setting of output current

When resistors for setting of output current ( $R_{\text{EXT}}$ ) are used commonly by many ICs, in designing for mass production, take enough care in evaluating IC operation.

### 3. Regarding PCB layout

There is only one GND terminal on this device when the inductance in the GND line and the resistor are large, the device may malfunction due to the GND noise when output switching by the circuit board pattern and wiring.

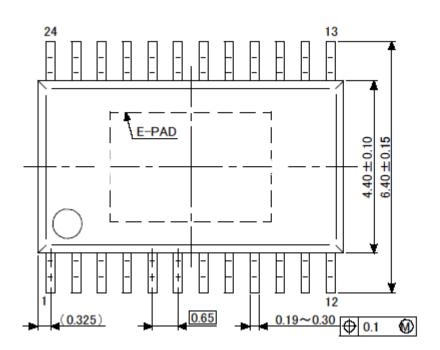
Therefore, take care when designing the circuit board pattern layout and the wiring.

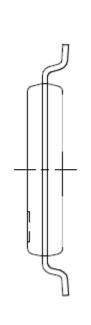
4. Please check the latest technical data sheet at the time of mass production.



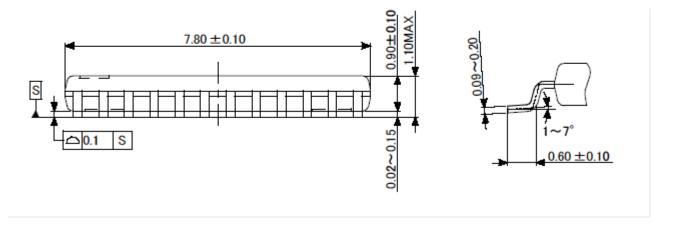
# Package dimension

# P-HTSSOP24-0508-0.65-001





Unit: mm



Weight: 0.10 g (Typ.)



#### **Notes on Contents**

#### 1. Block Diagrams

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

#### 2. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

#### 3. Timing Charts

Timing charts may be simplified for explanatory purposes.

#### 4. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially at the mass production design stage.

Providing these application circuit examples does not grant a license for industrial property rights.

#### 5. Test Circuits

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

### IC Usage Considerations

### Notes on handling of ICs

- [1] The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.
  - Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
- [2] Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- [3] If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition.
  - Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- [4] Do not insert devices in the wrong orientation or incorrectly.
  - Make sure that the positive and negative terminals of power supplies are connected properly.
  - Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
  - In addition, do not use any device that is applied the current with inserting in the wrong orientation or incorrectly even just one time.
- [5] Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.
  - If there is a large amount of leakage current such as input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure can cause smoke or ignition. (The over current can cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection type IC that inputs output DC voltage to a speaker directly.



#### Points to remember on handling of ICs

#### (1) Heat Radiation Design

In using an IC with large current flow such as power amp, regulator or driver, please design the device so that heat is appropriately radiated, not to exceed the specified junction temperature (T<sub>J</sub>) at any time and condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, please design the device taking into considerate the effect of IC heat radiation with peripheral components.

#### (2) Back-EMF

When a motor rotates in the reverse direction, stops or slows down abruptly, a current flow back to the motor's power supply due to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

(3) Thermal Shutdown Circuit

Thermal shutdown circuits do not necessarily protect ICs under all circumstances. If the thermal shutdown circuits operate against the over temperature, clear the heat generation status immediately.

Depending on the method of use and usage conditions, such as exceeding absolute maximum ratings can cause the thermal shutdown circuit to not operate properly or IC breakdown before operation.

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#### Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
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- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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